## TS8P01G – TS8P07G Taiwan Semiconductor

# 8A, 50V - 1000V Standard Bridge Rectifier

## FEATURES

TAIWAN

• AEC-Q101 qualified available

SEMICONDUCTOR

- Glass passivated chip junction
- Ideal for printed circuit board
- Typical IR less than 0.1µA
- High surge current capability
- UL Recognized File # E-326243
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

## APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

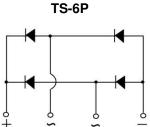
## **MECHANICAL DATA**

- Case: TS-6P
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Mounting torque: 0.92 N·m maximum
- Polarity: As marked
- Weight: 7.15g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I <sub>F</sub>	8	А			
V <sub>RRM</sub>	50 - 1000	V			
I <sub>FSM</sub>	200	А			
T <sub>J MAX</sub>	150 °C				
Package	TS-6P				
Configuration	Quad				



**ROHS** HALOGEN



PARAMETER	SYMBOL	TS8P	TS8P	TS8P	TS8P	TS8P	TS8P	TS8P	UNIT
		01G	02G	03G	04G	05G	06G	07G	
Marking code on the device		TS8P 01G	TS8P 02G	TS8P 03G	TS8P 04G	TS8P 05G	TS8P 06G	TS8P 07G	
Repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Forward current	I <sub>F</sub> 8			А					
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	200			A				
Rating of fusing (t<8.3ms)	l <sup>2</sup> t 166		A <sup>2</sup> s						
Junction temperature	T <sub>J</sub> - 55 to +150			°C					
Storage temperature	T <sub>STG</sub> - 55 to +150			°C					

1



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-case thermal resistance	R <sub>eJC</sub>	1.4	°C/W

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT	
Forward voltage per diode <sup>(1)</sup>	$I_F = 4A, T_J = 25^{\circ}C$	V <sub>F</sub>	-	1.0	V	
	$I_F = 8A, T_J = 25^{\circ}C$		-	1.1	V	
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>	$T_J = 25^{\circ}C$	I <sub>R</sub>	-	10	μA	
	T <sub>J</sub> = 125°C		-	500	μA	

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING		
TS8PxG	TS-6P	15 / Tube		
TS8PxGH	TS-6P	15 / Tube		

Notes:

1. "x" defines voltage from 50V(TS8P01G) to 1000V(TS8P07G)

"H" means AEC-Q101 qualified 2.



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

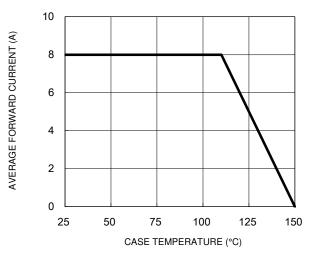
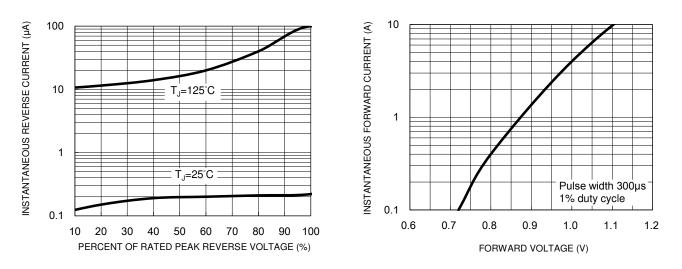


Fig.1 Forward Current Derating Curve

### Fig.3 Typical Reverse Characteristics



1000

100

10

0.1

CAPACITANCE (pF)

#### 225 200 PEAK FORWARD SURGE CURRENT (A) 8.3ms single half sine wave 175 150 125 100 75 50 25 0 10 100 1 NUMBER OF CYCLES AT 60 Hz 3

### Fig.5 Maximum Non-Repetitive Forward Surge Current

Fig.2 Typical Junction Capacitance

1

10

REVERSE VOLTAGE (V)

**Fig.4 Typical Forward Characteristics** 

100

f=1.0MHz Vsig=50mVp-p

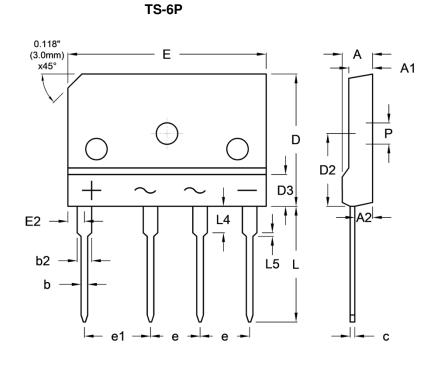
Version: M2203



# TS8P01G – TS8P07G

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## PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit	(inch)	
Divi.	Min.	Max.	Min.	Max.	
A	4.40	4.80	0.173	0.189	
A1	3.40	3.80	0.134	0.150	
A2	2.50	2.90	0.098	0.114	
b	0.90	1.10	0.035	0.043	
b2	2.00	2.40	0.079	0.094	
с	0.65	0.75	0.026	0.030	
D	19.70	20.30	0.776	0.799	
D2	10.80	11.20	0.425	0.441	
D3	-	4.80	-	0.189	
E	29.70	30.30	1.169	1.193	
E2	2.30	2.70	0.091	0.106	
е	7.30	7.70	0.287	0.303	
e1	9.80	10.20	0.386	0.402	
L	17.00	18.00	0.669	0.709	
L4	3.80	4.20	0.150	0.165	
L5	0.45	0.65	0.018	0.026	
Р	3.10	3.40	0.122	0.134	

## **MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound
- YWW = Date Code
- F = Factory Code



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